

Vishay Siliconix

RoHS

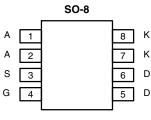
COMPLIANT HALOGEN

FREE

P-Channel 30 V (D-S) MOSFET with Schottky Diode

| MOSFET PRODUCT SUMMARY | | | | | | |
|------------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | | |
| - 30 | 0.068 at V _{GS} = - 10 V | - 4.6 | 4.6 | | | |
| | 0.110 at V _{GS} = - 4.5 V | - 3.4 | 4.0 | | | |

SCHOTTKY PRODUCT SUMMARY V_F (V) V_{KA} (V) **Diode Forward Voltage** I_D (A)^a 30 0.44 V at 1 A 2



Top View

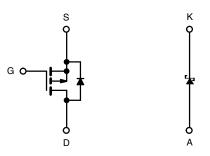
Ordering Information: Si4833BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 • Definition
- LITTLE FOOT[®] Plus Power MOSFET •
- 100 % R_a Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Battery Management in Notebook PC •
- Non-synchronous Buck Converter in HDD •



P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ | °C, unless otl | herwise noted) | | | |
|--|------------------------|-----------------------------------|-----------------------|----|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage (MOSFET) | | V _{DS} | - 30 | | |
| Reverse Voltage (Schottky) | | V _{KA} | - 30 | V | |
| Gate-Source Voltage (MOSFET) | | V _{GS} | ± 20 | | |
| | T _C = 25 °C | | - 4.6 | | |
| Continuous Drain Current (T _J = 150 °C) (MOSFET) | T _C = 70 °C | I _D | - 3.6 | | |
| Continuous Drain Current $(T_j = 150 \text{ C}) (\text{MOSFET})$ | T _A = 25 °C | טי | - 3.8 ^{b, c} | | |
| | T _A = 70 °C | 1 1 | - 3 ^{b, c} | | |
| Pulsed Drain Current (MOSFET) (t = 300 µs) | · | I _{DM} | - 20 | А | |
| Continuous Coursest (MOSEET Diada Conduction) | | ۱ _S | - 2 | | |
| Continuous Source Current (MOSFET Diode Conduction) | T _A = 25 °C | 'S | - 1.4 ^{b, c} | | |
| Average Forward Current (Schottky) | ۱ _F | - 1.4 ^b | | | |
| Pulsed Forward Current (Schottky) | I _{FM} | - 2 | | | |
| | T _C = 25 °C | | 2.75 | | |
| | T _C = 70 °C | PD | 1.75 | w | |
| Maximum Power Dissipation (MOSFET and Schottky) | T _A = 25 °C | טי | 1.75 ^{b, c} | vv | |
| | T _A = 70 °C | | 1.10 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | |
|----------------------------|--|
| - | |

| Parameter | Symbol | Typical | Maximum | Unit |
|--|-------------------|---------|---------|------|
| Maximum Junction-to-Ambient (MOSFET and Schottky) ^{b, c, d} | R _{thJA} | 60 | 71.5 | °C/W |
| Maximum Junction-to-Foot (Drain) (MOSFET and Schottky) | R _{thJF} | 35 | 45 | 0/11 |

Notes:

a. Based on $T_C = 25$ °C.

b. Surface mounted on FR4 board.

c. t ≤ 10 s.

d. Maximum under steady state conditions is 120 °C/W.

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|------------------------|---|--------|--------|-------|-------|--|
| Static | - | | | | | I | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{DS} = 0 V, I_{D} = -250 \mu A$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS/TJ}$ | 1 050 | | - 20 | | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)/TJ}$ | I _D = - 250 μA | | 3.9 | | mV/°C | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1 | - 1.8 | - 2.5 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| | | $V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | - 1 | μΑ | |
| Zero Gate Voltage Drain Current | I _{DSS} | V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 75 °C | | | - 10 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge$ - 5 V, V_{GS} = - 10 V | - 5 | | | А | |
| | 5 | V _{GS} = - 10 V, I _D = - 3.6 A | | 0.055 | 0.068 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 2.8 A | | 0.092 | 0.110 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 3.6 A | | 6.5 | | S | |
| Dynamic ^b | | L | L | | L | | |
| Input Capacitance | C _{iss} | | | 350 | | | |
| Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 75 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 63 | | | |
| T + 1 0 + 01 | | V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 5 A | A 9 14 | 14 | | | |
| Total Gate Charge | Qg | V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 5 A | | 4.6 | 7 | | |
| Gate-Source Charge | Q _{gs} | | | 1.3 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 2.1 | | | |
| Gate Resistance | R _g | f = 1 MHz | 1.5 | 7.3 | 14.5 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 28 | 50 | | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 3 Ω | | 73 | 140 | | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_\text{D}\cong$ - 5 A, V_GEN = - 4.5 V, R_g = 1 Ω | | 12 | 24 | | |
| Fall Time | t _f | | | 8 | 16 | - | |
| Turn-On Delay Time | t _{d(on)} | | | 6 | 12 | ns | |
| Rise Time | t _r | V_{DD} = - 15 V, R_L = 3 Ω | | 9 | 18 | | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_\text{D}\cong$ - 5 A, V_GEN = - 10 V, R_g = 1 Ω | | 12 | 24 | | |
| Fall Time | t _f | | | 6 | 12 | | |
| Drain-Source Body Diode Characteristic | cs | | | | | | |
| Continous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | - 4.6 | ^ | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 20 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 2 A, V _{GS} = 0 V | | - 0.83 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 12 | 24 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | l _F = - 2 A, dl/dt = 100 A/μs, T _J = 25 °C | | 6 | 12 | nC | |
| Reverse Recovery Fall Time | t _a | $F = -2 A$, $u/u = 100 A/\mu s$, $T_J = 25 C$ | | 8 | | | |
| Reverse Recovery Rise Time | t _b | | | 4 | | ns | |

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.



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| SCHOTTKY SPECIFICATIONS (T_J = 25 °C, unless otherwise noted) | | | | | | | |
|--|-----------------|--|------|------|------|------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Forward Voltage Drop | VE | I _F = 1 A | | 0.36 | 0.44 | V | |
| | ۴F | I _F = 1 A, T _J = 125 °C | | 0.29 | 0.35 | v | |
| Maximum Reverse Leakage Current | I _{rm} | V _R = 30 V | | 0.03 | 0.2 | mA | |
| | | V _R = 30 V, T _J = 75 °C | | 0.6 | 5 | | |
| | | V _R = 30 V, T _J = 125 °C | | 7.5 | 60 | | |
| Junction Capacitance | CT | V _R = 15 V | | 5.3 | | pF | |

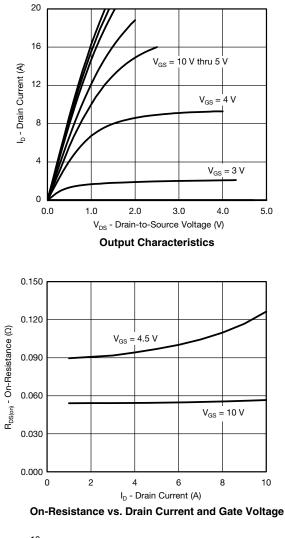
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

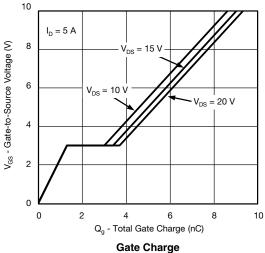
Si4833BDY

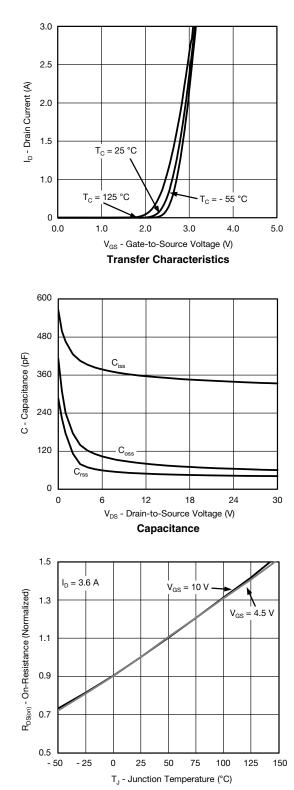


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MOSFET TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







On-Resistance vs. Junction Temperature

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Document Number: 67537 S11-1649-Rev. B, 15-Aug-11

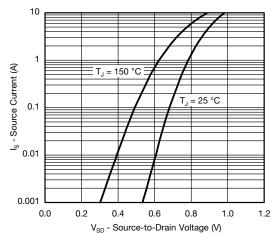
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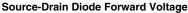
AIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

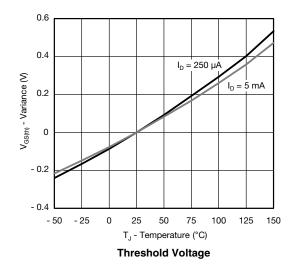


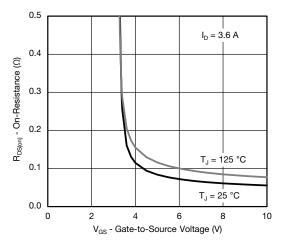
Si4833BDY Vishay Siliconix

MOSFET TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

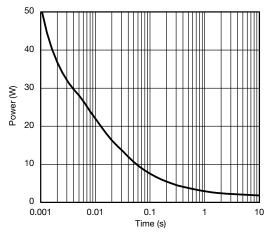




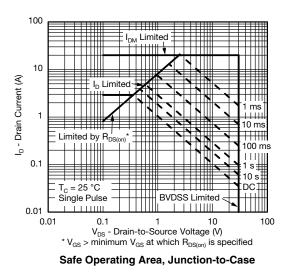




On-Resistance vs. Gate-to-Source Voltage



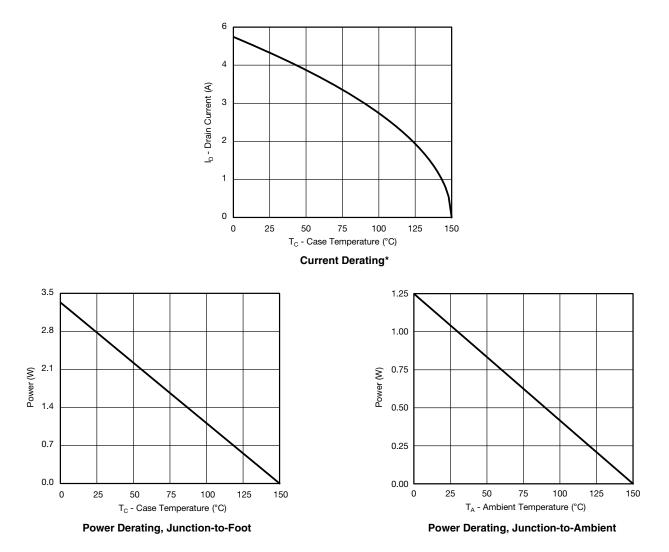
Single Pulse Power, Junction-to-Ambient



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MOSFET TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

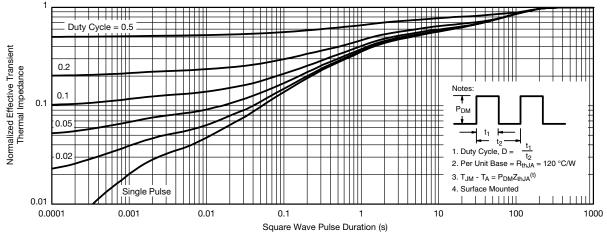


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

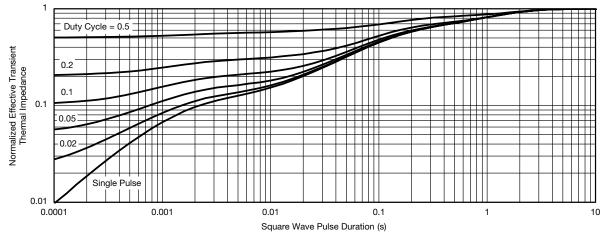


Si4833BDY Vishay Siliconix

MOSFETS TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







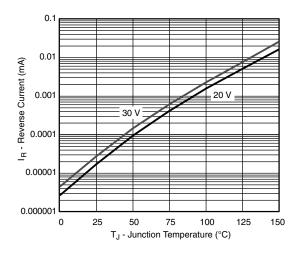
Normalized Thermal Transient Impedance, Junction-to-Foot

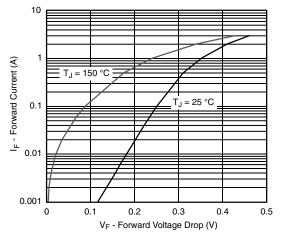
Si4833BDY



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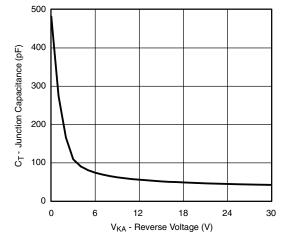
SCHOTTKY TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Reverse Current vs. Junction Temperature

Forward Voltage Drop



Capacitance

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67537.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





| | MILLIM | IETERS | INCHES | | | |
|---|--------|--------|-----------|-------|--|--|
| DIM | Min | Мах | Min | Max | | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 BSC | | | |
| н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | | |

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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